Comparison of a-Fe2O3 electrodes grown by direct plasma and thermal oxidation of iron for photoelectrochemical water splitting.

Boris David Chernomordik
University of Louisville

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COMPARISON OF $\alpha$-Fe$_2$O$_3$ ELECTRODES GROWN BY DIRECT PLASMA AND THERMAL OXIDATION OF IRON FOR PHOTOELECTROCHEMICAL WATER SPLITTING

By

Boris David Chernomordik
B.S., University of Louisville, 2008

A Thesis
Submitted to the Faculty of the
University of Louisville
J.B. Speed School of Engineering
as Partial Fulfillment of the Requirements
For the Professional Degree

MASTER OF ENGINEERING

Department of Chemical Engineering

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Submitted by: __________________________________________

Boris David Chernomordik

A Thesis Approved on

____________________
(Date)

By the Following Reading and Examination Committee:

____________________________________

Mahendra K. Sunkara, PhD, Thesis Director

____________________________________

Moises A. Carreon, PhD

____________________________________

Richard P. Baldwin, PhD
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ABSTRACT

Iron oxide, Fe₂O₃, is a promising material for water splitting reaction using solar energy due to its stability and optimal bandgap of 2 eV. Even the recent efforts, however, using Fe₂O₃ thin film materials reported low efficiencies due to poor carrier transport within these films.

A novel plasma oxidation method was used to synthesize arrays of α-Fe₂O₃ which are single crystal and have highly ordered oxygen vacancy planes. As one-dimensional nanostructures, these nanowires offer many other benefits to photoelectrochemical electrolysis, including high surface area, reduced charge carrier diffusion distance, and a preferential direction for charge diffusion. Furthermore, due to the ordered-oxygen vacancy planes in these nanowires, the high resistivity that has plagued this material may become a non-issue.

The photoelectrochemical performance of these samples was compared to that of nanowire (and nanobelt) arrays grown by thermal oxidation of iron foils. Hematite samples grown by plasma oxidation were found to have considerably greater photoactivity than by thermal oxidation. This was attributed to the presence of a large (7.5 µm) mixed-phase interfacial layer in the latter, wherein the charge carriers are lost to recombination. Due to the fast growth process in plasma oxidation, the interfacial layer is much thinner (1 µm) and may in fact contain only hematite, rather than a mixed phase. Studies are currently underway to determine the interfacial layer composition.

It is concluded that further studies of hematite for photoelectrochemical electrolysis should be performed using nanowire arrays grown by direct plasma oxidation.
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I. INTRODUCTION AND MOTIVATION

Energy is one of the most fundamental societal necessities. Currently, we are facing a global problem with regard to sources of energy. The global energy demand is 13+ TW (as of 2001), and is ever increasing. That is approximately equivalent to the energy output of an astounding 13,000 nuclear power plants. A large majority of our current energy supply and consumption is dominated by fossil fuels (oil, coal, natural gas)\[1, 2\]. These resources are nearing their limits, poisoning the environment, hurting our health, and contributing to international conflicts. Energy is tied to every aspect of society. For example, scarcity causes cost spikes which contribute to slowing economic growth, begetting social upheaval. Energy should be cheap, clean, and globally available: cheap because it is the foundation for all other development, clean to avoid health problems and associated costs and to minimize impact on the environment, and globally available so that a few nations never hold the world’s energy supply for ransom.

Several alternative energy sources are available, including solar-derived, wind, geothermal, biomass, hydro, wave, nuclear and hydrogen. Geothermal, hydro, and wave are very clean but site-specific resources that may benefit a local region but cannot begin to address the global energy demand. Biomass, though promising, should not compete with the global agriculture, agriculture-dependent industries, such as feedstock and fertilizer, or put pressure on utilization of protected lands. There may also be issues regarding harmful emissions from burning biofuels as well as whether the energy output is greater than the energy input. Satisfying the global energy needs with nuclear technology would require an astonishing number of nuclear plants, together producing a large quantity of nuclear waste endangering the safety and health of local populations for
many generations. Another issue is that global uranium resources are limited. Solar and wind are capable of meeting significant energy demands. Solar alone can fulfill our energy requirements. The amount of energy falling on our planet is roughly equivalent to $1.2 \times 10^5$ TW, enough to meet our global energy demand many times over for many years to come. The vast portion of that energy is wasted, such as on heating parking lots, however. Solar and wind collecting devices are capable of supplying energy for immediate use, but must be coupled with an energy storage device to provide energy during the times when there is no sunlight or wind. Batteries are an expensive solution which has a number of technical and practical obstacles. Hydrogen is chemically stored energy. When converted to electricity in a fuel cell, coupling hydrogen derived from the electrochemical splitting of water with a renewable energy source is the cleanest possible fuel.

The byproducts of electrochemical splitting of water are hydrogen and oxygen gases. These may be recombined in a fuel cell to produce water and electricity. It is in essence a closed loop fuel cycle, except that energy must be put in and out. If that energy input is solar radiation, then the result is a clean and possibly inexhaustible energy supply. One method of obtaining hydrogen electrochemically involves an electrolyzer—powered by solar panels, for example. Commercial electrolyzers typically use platinum, an expensive and precious metal. This two-part operation would add significantly to the capital involved in collecting hydrogen. Instead, there is significant interest in semiconductor-based devices that can harness solar radiation to drive the electrochemical water splitting reaction on the semiconductor surface. In fact, direct
photoelectrochemical (PEC) water splitting using sunlight is described as the “Holy Grail” of electrochemistry[3, 4].
II. THEORY

**Photoelectrolysis**

The following net reaction describes the electrolysis of water:

\[ \text{2H}_2\text{O}(l) \leftrightarrow \text{2H}_2(g) + \text{O}_2(g) \quad \Delta E^o = -1.23 \text{ eV} \quad (1) \]

It is composed of two half-reactions. Hydrogen gas is produced at the cathode by the reduction half-reaction, which is defined as 0V on the electrochemical scale when it occurs in pH = 0:

\[ 2\text{H}^+(aq) + 2e^- \leftrightarrow \text{H}_2(g) \quad E^o = 0.00 \text{ eV} \quad (2) \]

This electrochemical reference point is defined as the Normal Hydrogen Electrode (NHE) potential. Oxygen gas is evolved on the anode during the oxidation half-reaction:

\[ \text{2H}_2\text{O}(l) \leftrightarrow \text{O}_2(g) + 4\text{H}^+(aq) + 4e^- \quad E^o = -1.23 \text{ eV} \quad (3) \]

These reactions occur at the two respective electrodes. Thus, simple physical separation may allow the gases to be collected and stored separately.

This electrolysis is a non-spontaneous reaction, which means that it requires energy input. As shown in Equation (1), the minimal energy requirement is 1.23 eV. Using the following relation:

\[ \lambda = \frac{hc}{eE}, \quad h = 6.625 \cdot 10^{-34} J \cdot s, \quad c = 2.998 \cdot 10^{17} \frac{nm}{s}, \quad e = 1.60 \cdot 10^{-19} C \quad (4) \]
(where \( \lambda \) is wavelength in nanometers, \( h \) is Planck’s constant, \( c \) is the speed of light in vacuum, \( e \) is the electronic charge magnitude, and \( E \) is the energy of the photon in eV), the energy requirement to split water corresponds to radiation with a wavelength of 1010 nm. Photons with energy greater than 1.23 eV (or wavelength less than 1010 nm), which encompass the visible light spectrum, can drive the electrolysis reaction. The integrated solar irradiance is Earth’s atmosphere filters portions of the solar spectrum and the radiation intensity decreases as distance light travels through the atmosphere increases (in adherence to the Beer-Lambert Law). The “AMX” (air mass) standard was developed to reflect this effect, where “X” is the air mass coefficient:

\[
X = \frac{I}{I_0} = \frac{I_0}{I_0 \cos \theta} = \frac{1}{\cos \theta}
\]

where \( I_0 \) is the light intensity before entering the atmosphere, \( I \) is the intensity after light travels a particular distance through the atmosphere, and \( \theta \) is the solar zenith angle—measured between the straight path of light to a point and the normal. The following are the air mass conventions and their meanings: AM0 for the solar flux in space, AM1 for the terrestrial solar flux normal to the surface, and AM1.5 for the terrestrial solar flux at a zenith angle of 48.2º. AM1.5 is the accepted standard for solar cell analysis and reflects the day-average solar radiation, with the irradiance rounded to 1000 W/m². The AM0 and AM1.5 solar spectra are shown in Figure 1.
Figure 1. Solar spectra corresponding to AM0 and AM1.5 standards[5].

Semiconductor materials are capable of absorbing light energy to drive an electrochemical reaction. Semiconductors may also be used to perform photolysis, the decomposition of a chemical compound using a photoactive catalyst, for a number of applications including decomposition of hazardous waste. A significant amount of research in this area is devoted to solar fuels, particularly photoelectrochemical electrolysis for hydrogen generation.

The fundamental components of a PEC cell are the cathode and anode, both or either of which may be a semiconductor. If the anode is a photoactive semiconductor material, then it is called a photo-anode. N-type semiconductors are photo-anodes because they drive the water oxidation reaction; p-type semiconductors are photo-
cathodes because they drive the reduction reaction (detailed explanation may be found later in the text). If only one electrode is a semiconductor, it is considered the working electrode (WE) and a noble metal is typically chosen to serve as the counter electrode (CE). A third electrode, the reference electrode (RE), is also commonly when testing PEC performance of a semiconductor. In a two-electrode cell, the potentiostat applies a bias between the WE and CE, but one does not know how the bias is distributed between the two electrodes. In a three electrode measurement, the desired bias is applied to the WE with respect to the RE. Thus, in the latter case, potential on the WE is known. The bias on the CE, however, varies according to the flow of charges. Three electrode measurements do not indicate the bias between the WE and the CE. That has to be determined by connecting a multimeter. Essentially, a three electrode measurement focuses on the behavior of the WE and does not report what is happening at the CE. A common reference electrode is Ag/AgCl. Figure 2 illustrates a typical three-electrode PEC cell involving a photo-anode WE, platinum CE, and a reference electrode (RE). Upon illumination by sunlight, the generated electrons flow from the bulk of the photo-anode to the cathode, whereupon they participate in the evolution of hydrogen. The positively charged holes oxidize water at the surface of the photo-anode to produce oxygen and positive ions.
Semiconductor Principles:

The conductivity type of a semiconductor (n-type or p-type) is determined by its Fermi level position. A characteristic property of semiconductors is the band gap ($E_g$), an energy minimum representing the separation between the valence and conduction bands, as illustrated in Figure 3. The promotion of an electron from the valence band—also called the highest occupied molecular orbital (HOMO)—to the conduction band—or, lowest unoccupied molecular orbital (LUMO)—occurs and the electron is free to move within the lattice. Consequently, the free-electron leaves behind a hole—a positive charge signifying the absence of an electron—in the valence band. The hole is also free to move within the lattice, through the propagation of a free electron, in the opposite direction. In the case of a direct band gap semiconductor, energy input equal to or greater
than $E_g$ will allow an electron to conduct through the lattice. Some materials exhibit an indirect band gap, however. Although the band gap is still the minimum separation between the valence band maximum and the conduction band minimum, these points are offset by a finite momentum, $p$. Mathematically, the bands are represented by a parabolic relationship between energy, $E$, and crystal momentum, $k$:

$$E - E_c \text{ or } E_v - E = \frac{p^2}{2m} = \frac{\hbar^2 k^2}{2m}$$

(6)

where $m$ is the effective mass of the particle ($m_e^*$ for electron in $E_c$ and $m_h^*$ for hole in $E_v$), and $\hbar$ is the reduced Planck’s constant ($\hbar = \frac{\hbar}{2\pi}$). Equation (6), represents a free particle, but the relationship becomes complex in an actual crystal because of particle interaction with the atoms and due to crystal structure and direction. Figure 4 shows an $E$ versus $k$ band diagram for a hypothetical semiconductor material with a direct band gap (a) and an indirect band gap (b). As before, the upper line is the conduction band and the lower line is the valence band. In 5a, the conduction band minimum lines up with the valence band maximum along $k=0$. This is the case for direct band gap materials, such as GaAs, and it is an important feature for applications in optical devices including light emitting diodes. In 5b, the conduction band minimum occurs along the [100] crystal direction, rather than at $k=0$. In this case, an interaction with the crystal is necessary for an electron to transition from $E_v$ to $E_c$. The measure of this interaction is a phonon, a quantized measure of a crystal lattice vibration. Therefore, the crystal must absorb a photon with an energy $E_g$ and a phonon, or heat. An indirect band gap material can also experience a direct transition if the absorbed energy is equivalent to the gap at $k=0$. Silicon is an example of an indirect band gap material, which has nonetheless found wide
acceptance for photovoltaics out of commercial practicality. Light can penetrate farther into an indirect band gap material without exciting an electron across the band gap because absorption of a photon and phonon must happen simultaneously. This is why silicon solar cells are typically hundreds of microns thick.

Figure 3. Schematic showing the excitation of an electron from the valence band to the conduction band.
The conduction and valence bands are simply two states which charges may occupy, but there exists a density of states above and below, respectively, which may be occupied. The probability of these states being occupied is represented by the Fermi-Dirac distribution function:

$$\frac{N(E)}{g(E)} = f_F(E) = \frac{1}{1 + \exp \left( \frac{E - E_F}{kT} \right)}$$  \hspace{1cm} (7)$$

Where $N(E)$ is the number of particle (electrons) per unit volume per unit energy, $g(E)$ is the density of quantum states (number per unit volume) per unit energy, $k$ is the Boltzmann constant, and $T$ is temperature in Kelvin. When $E = E_F$, the Fermi energy, the

Figure 4. A schematic of the energy versus momentum (k) diagram for direct (a) and indirect (b) band gap semiconductors.
Fermi-Dirac distribution is equal to ½, or 50%. The Fermi energy is not an occupiable state, but it does represent an energy level has a 50% probability of being occupied. In electrochemistry, the Fermi level is the electrochemical potential (µ) of electrons in the semiconductor solid. For a simple redox couple, the Fermi level is given by:

$$E_{F,\text{redox}} = \bar{\mu}_{e,\text{redox}} = \mu_{\text{redox}}^o + kT \ln \left( \frac{c_{\text{ox}}}{c_{\text{red}}} \right)$$  \hspace{1cm} (8)

where \(c_{\text{ox}}\) and \(c_{\text{red}}\) are the concentrations of oxidized and reduced species. For a simple visual interpretation one can imagine that the Fermi level would nearer the band edge where with the highest concentration of electrons (in the case of \(E_c\)) or holes (in the case of \(E_v\)).

Introducing donor or acceptor states can shift the Fermi level and so define the conductivity type of a semiconductor (n- or p-type). In an intrinsic semiconductor, such as undoped silicon, the Fermi level is at midgap between the conduction and valence bands. “Impurity” atoms introduced into a crystal lattice can donate electrons or holes. For example, doping silicon with phosphorous atoms creates n-type silicon. Whereas silicon has four valence electrons, phosphorous has five, thus it is capable of donating an electron to the crystal—like water poured from the top of a hill jutting out of the ocean. For p-type, the dopant atom has fewer valence electrons than the atoms surrounding it and thus acts as an acceptor of electrons from the crystal. For doping, the concentration of impurity atoms in the crystal is typically on the order of \(10^{15}\) to \(10^{19}\) cm\(^{-3}\). The presence of dopants influences the distribution of charge carriers below and above the band gap. For n-type semiconductors, the density of occupied states above the conduction band is increased, and consequently the Fermi level rises nearer to the
conduction band. For p-type, the Fermi level is nearer the valence band. This is schematically shown in Figure 5. Reference [6] pertains to the above discussion.

![Figure 5](image)

**Figure 5.** A schematic of the Fermi level position in n-type (a) and p-type (b) semiconductors.

In the presence of an electrolyte, the semiconductor Fermi level equilibrates with that of the electrolyte[7, 8]. The energy levels for a photoanode and metal cathode before contact, in dark, and under illuminations are shown in Figure 6. These schematics plot voltage on an electrochemical scale (up = negative, 0 = NHE) versus a single space dimension. Thus, when referring to the band diagram, a rise corresponds to a negative potential shift, and vice versa. The electrolyte Fermi level is somewhere between the O₂/H₂ redox couple—depending on the concentration—and is a function of the Gaussian type distribution of redox states, which is detailed further in a number of review articles[7, 9-11]. In the case of an n-type, the electrochemical potential is greater within the semiconductor than in the electrolyte. As a result, electrons diffuse from the solid surface into the solution. This leaves the semiconductor surface positively ionized, creating a space charge region. Consequently, oppositely charged ions congregate on the
electrolyte side of the interface, creating a charge double layer called the Helmholtz layer. On the band diagram, this effect is represented by the bending of the conduction and valence bands. The band edge positions at the interface are pinned and do not change throughout the interaction because they are a function of the Helmholtz layer parameters, which depend on the specific material-electrolyte interaction. The bulk of the semiconductor does not “see” the Helmholtz layer, however, and may experience a redistribution of electrochemical potential. This is manifested by the shifting of the Fermi level, which is a bulk material property. The energy gaps between the band edges and the Fermi level are functions of the material and remain constant, forcing the bands to move in congress with the Fermi level. The space charge region where the bands are bent contains an electric field, the direction of which is determined by the relative position of the Fermi level to the electrolyte redox potential. In an n-type semiconductor, the bands shift downward (more positive) in order to reach equilibrium, thus creating a field that drives electrons, the majority carrier, away from the interface. Consequently, holes are driven into the solution to perform oxidation. In a p-type semiconductor, the bands shift upward (more negative) to raise the Fermi level, creating a field that drives electrons into the solution. At the photocatalyst, photoelectrolysis is therefore a minority carrier driven process. On the counter electrode side, the metal has a much larger carrier density and is able to match the semiconductor Fermi level as it shifts. Upon illumination, the photogenerated charges counteract the electric field in the space charge layer, thereby flattening the bands to a degree dependant on the illumination intensity. With enough illumination, the semiconductor Fermi level will be at the flat band
potential, $U_{fb}$, which is the maximum (minimum in case of n-type) Fermi level possible without an external bias.

The n-type semiconductor Figure 6 a-d cannot split water without an external bias because the flat band potential of the semiconductor is below the hydrogen evolution potential. In (a), the metal Fermi level is aligned with that of the solution, but the semiconductor has not made contact with the electrolyte yet. In (b), the two electrodes are connected by a junction and both are in the electrolyte. The Fermi level of the semiconductor lines up with the electrolyte Fermi level. Due to band edge pinning, this causes the bulk bands to bend downward. In (c), the semiconductor is illuminated, creating photogenerated carriers that counteract the field in the space charge region, thus reducing band bending. Electrons that move through bulk to the metal still do not have enough energy for hydrogen evolution. Therefore, in (d), an external positive bias, $E_b$, is applied. As discussed before, the bias the distributed between both electrodes, thus lower the semiconductor Fermi level and raising the metal Fermi level. With enough bias, the electrons may reduce water. For a p-type semiconductor with $U_{fb}$ too high, a negative bias is applied which raises the semiconductor Fermi level and lowers that for the metal. The ideal situation for a photoanode capable of self-driven water splitting is shown in (e).
Figure 6. Energy level diagrams for n- and p-type semiconductors in electrolyte during photoelectrolysis. Figures (a) – (d) show the energy levels for an n-type semiconductor before contact with electrolyte or cathode, in equilibrium with the electrolyte and cathode in dark, with high intensity illumination, and with illumination and positive bias, respectively. In the latter figures, the semiconductor requires bias to perform photoelectrolysis, whereas the hypothetical n-type semiconductor in (e) does not need bias because its bands straddle the water splitting redox potentials. Figure (f) represents a p-type semiconductor at equilibrium in dark—correlating to (b).
PEC Material Requirements:

There are a number of challenges associated with searching for a suitable and stable material for performing photolysis. The criteria are[12]:

1) Band gap energy between 1.7 eV and 2.2 eV (roughly).

2) Appreciable reaction kinetics and charge carrier conductivity

3) The energies of the highest unoccupied and lowest occupied molecular orbitals “straddle” the redox potentials for water decomposition.

4) Stability in aqueous environments.

5) Earth-abundant, inexpensive, mass-producible

The minimum band gap requirement is dictated by the minimum energy needed to split water (1.23 eV), thermodynamic losses, and overpotentials needed to increase the reaction kinetics. The upper band gap requirement ensures that the semiconductor absorbs a significant portion of the terrestrial solar spectrum. It is not enough that the semiconductor absorb the photons, however, because it also must be able to separate and conduct the electrons and holes. As for stability, the semiconductor electrode may undergo corrosion. The third requirement refers to the relative energy band positions of the semiconductor. Essentially, the energy of the valence band should be greater than the water oxidation potential (1.23 eV vs. Normal Hydrogen Electrode) and the energy of the conduction band should be less than the water reduction potential (0 eV vs. NHE). The kinetics of charge transfer from the surface to the electrolyte must be faster than the decomposition reaction. For example, TiO$_2$ has excellent stability in a wide range of pH
levels whereas the corrosion of ZnO by oxidation is preferred over oxidation of water by the holes[13]. ZnO is stable as a photo-cathode (p-type), however, because the water reduction potential is greater than the reduction corrosion potential. Finally, the material cannot be composed of precious elements or else its application would be limited from the beginning due to economical impracticality. An expensive high-performance PEC system simply cannot be the solution. Similarly, there should exist, or be developed, a method for inexpensive mass-production in order to commercially feasible.

Efficiency

To date, the highest measured photoconversion efficiency for a photoelectrochemical cell is 12.4%, which was achieved at NREL using a GaInP$_2$/GaAs monolithic tandem cell[14]. That cell exhibited significant degradation, however. The photoconversion efficiency (STH)—also called solar to hydrogen conversion efficiency—is calculated using Equation (9)[15],

$$\varepsilon = \frac{1.229I_p}{P_t}$$  \hspace{1cm} (9)

where, the constant 1.229 is expressed in volts, $I_p$ is photocurrent in A/m$^2$, and $P_t$ is the input power (or light irradiance) in W/m$^2$. The constant comes from dividing the standard Gibbs energy for hydrogen evolution at 25 °C and 1 bar (237.2 kJ/mol) by number of moles of electrons used to generate 1 mol of H$_2$ [4], and by the Faraday constant (96485 C). The numerator and denominator are both in terms of power units, and therefore efficiency is the ratio of power output to power input. This method assumes standard temperature and pressure conditions and that all the carriers are utilized.
for evolving hydrogen and oxygen. The latter assumption is contradicted if the power output comes from photoelectrode corrosion. In order to use Eq. (9) to calculate efficiency, the photocurrent (current difference between dark and light conditions) must be generated without an external bias.

Although it is desirable for a photoelectrode to split water spontaneously upon illumination, some externally applied bias is most often necessary to encourage photocurrent. In such a case, Equation (9) must be modified as the following [15]:

\[
\varepsilon = \frac{(1.229 - V_{bias})I_p}{P_i}
\]

(10)

where, \(V_{bias}\) is the externally applied potential. \(V_{bias}\) is the potential difference between the working electrode (photoelectrode) and the counter electrode. It is preferred to determine efficiency from two-electrode measurements. For three electrode measurements, \(V_{bias}\) is not measured by the potentiostat and must be determined with an external voltmeter.

**Types of PEC Cells/Materials and Background Literature**

The criteria for solar-driven PEC electrolysis are so selective that few semiconductors meet even the most basic requirements—band gap, band edge positions, and stability—though many semiconductors have been examined. There are different routes by which an ideal material may be found, such as by synthesizing a new semiconductor or by modifying those already studied. The possibilities for the composition of new semiconductors are practically unlimited when considering multi-elemental materials. Likewise, there are many options by which weaknesses of known
materials may be decreased or the strengths augmented. As such, this has been an active
pursuit for many years and will continue to be so.

The most significant material types or strategies studied for solar-driven PEC may
be classified according to three categories:

- Metal-oxide
- Group IV and III-V
- Other

There may also be some overlap among these categories both in terms of new materials
and modifications. New materials are also being discovered—particularly those that are
higher order than ternary combinations, but these will not be discussed because the
reports are scarce.

**Metal Oxide:** The possibility of solar hydrogen production by solar-driven PEC
electrolysis was first discovered with TiO$_2$ (titania) in 1972[16], and it has been studied
continuously since then[17-29]. Titania is an attractive material for PEC because of its
superb stability in aqueous environments with a wide range of pH levels. Furthermore,
its band edges straddle the water reduction/oxidation potentials. As most oxides, it is a
natural photoanode (n-type). The major issue with titania, however, is its large band gap
($E_g \approx 3$ eV), which limits the amount of solar energy it is capable of absorbing,
significantly limiting the potential solar-to-hydrogen conversion efficiency. A large
portion of the research has been directed toward reducing the band gap or maneuvering
around the limitation. Attempts to decrease the band gap usually result in creating new
problems, such as increased degradation. In fact, the natural stability of titania has been
attributed its large band gap, an indicator of the chemical bond strength[30]. Several other metal oxides have also shared much of the spotlight but failed to impress due to wide band gap. These include ZnO[31-33], WO$_3$[34-38], SrTiO$_3$ [39-42], KTaO$_3$, Ta$_2$O$_5$, ZrO$_2$ [11], and SnO$_2$ [43]. Some researchers have chosen an indirect route to enhancing the PEC behavior of some metal oxides by instead augmenting other properties, such as surface area. One method involves using one-dimensional morphologies, which will be discussed later in this chapter.

Iron oxide is an interesting and promising material for solar water splitting. There are three main types of iron oxides—FeO, Fe$_2$O$_4$ (magnetite), and Fe$_2$O$_3$ (hematite)—but it is hematite (α-Fe$_2$O$_3$) which exhibits the desired properties[44-85]. It is an n-type semiconductor with an ideal (though indirect) band gap of ≈ 2.2 eV, which means it can absorb a large portion of the terrestrial solar spectrum. Hematite has also been shown to exhibit good stability over a wide pH range (pH > 3). It is particularly appealing because it is cheap, relatively easy to synthesize, environmentally benign, and composed of two of the most abundant elements on Earth. Hematite has had limited success as a PEC material for several reasons, however. As a pure-phase material, it is a known Mott-insulator, which means that, though charge separation occurs, charge transport properties are poor[68, 75, 81]; typically synthesized as low quality polycrystalline films, it exhibits high recombination rates due to crystal grain boundaries and unordered oxygen vacancies[86]; it exhibits anisotropic conductivity, wherein conductivity along the (001) plane is four orders of magnitude higher than in the [001] direction[45, 55, 81], which is again an issue for polycrystalline films; and the conduction band edge is typically ~0.2 eV too positive for unbiased hydrogen evolution[87]. It has been suggested that these
issues may be solved by inexpensive means of modifying the material. Several studies have shown significant improvements through doping/alloying—Ti[49, 51, 79], Si[47, 49, 56, 60], Pt[50], Ge[60], Mg[52, 72, 88], Zn[54, 65, 89, 90], Ta[91], Nb[87, 92], Cr, Mo[64], Cu[53], and Al-Ti[93]—and surface modification—Co[56], and Fluorine[51]. Of the studies, the most significant improvements have been attained by introducing Ti and Si, which increase the conductivity due to increased donor concentrations and, in the case of Si, improves crystallinity, reduces crystal size, and influences orientation of the (001) basal plane. As for surface modification, cobalt improves water oxidation catalysis and fluorine is claimed to lower the energy of the conduction band edge. Manipulating structural characteristics such as morphology and improving crystallinity may also reduce or eliminate the limitations, which is the focus of this study. Some positive results have already been shown with the use of nanorod structures, which are discussed in more detail later.

Several different methods have been developed for synthesizing hematite samples: single crystal synthesis[94, 95], ceramic processing[91], sol-gel[96-100], physical vapor deposition[101], chemical vapor deposition (CVD) [28, 56, 68, 71, 102], direct plasma oxidation[103-105], aqueous self-assembly[44, 106], electrochemical deposition[50, 64, 107-109], direct thermal oxidation [110-112], and spray pyrolysis[52, 53, 66, 89, 93]. The later is probably is most popular method among photoelectrochemical studies because it allows for easy introduction of precursors containing foreign impurities. Most of these methods produce polycrystalline films which have their own set inadvertent disadvantages, as discussed before, while some others are impractical for large scale synthesis. Both thermal oxidation and plasma-
assisted have been shown to reproducibly grow high quality nanostructures of hematite. Direct plasma oxidation, however, is quicker and may have other advantages, which this study attempts to show.

**Group IV and III-V:** There are many possible binary, ternary, and quaternary combinations of group III-V and IV elements that yield semiconductors with interesting properties. The advantage of these materials is that they are typically synthesized as high purity single crystal films using metal organic CVD, yielding high efficiencies. For PEC applications, the fatal flaw of these materials is poor stability and band edge mismatch. All binary III-V materials are aligned to drive the hydrogen evolution reaction, but only GaN is capable of evolving oxygen[113, 114]. GaN has a too wide band gap (3.4 eV), however. SiC, a binary group IV semiconductor, shares a similar fate. It is well aligned for water splitting and is stable against corrosion, but it too has an unacceptably wide band gap (3 eV)[115]. Furthermore, the high purity of these materials requires exuberantly expensive equipment and processing.

Elements from groups III and V may be combined in ternary, quaternary materials, and even higher order materials to yield interesting properties. Often, the intent is to find a happy medium between the properties of two or more semiconductors. For example, combining InN (0.7 eV) with GaN yields a InGaN with varying compositions and likewise varying band gaps (between those of InN and GaN)[116-119]. Other such materials studied for PEC applications include GaInP$_2$ [120-122], GaAsPN, GaPN, and GaInPN[123, 124]. GaAsPN exhibited high corrosion while GaP$_{0.98}$N$_{0.02}$ was found to have a band gap of 2 eV, but the introduction of N caused lattice mismatches between the underlying GaP layer and significantly reduced the efficiency. At the same
time, minute nitrogen concentrations were shown to reduce vulnerability of the material to corrosion. By using indium in $\text{Ga}_{0.962}\text{In}_{0.038}\text{P}_{0.976}\text{N}_{0.024}$ and $\text{Ga}_{0.95}\text{In}_{0.05}\text{P}_{0.975}\text{N}_{0.025}$, lattice mismatching was solved and these materials also had a direct band gap of 2 eV, but still exhibited low efficiencies.

A tandem cell is a combination of two or more semiconductor materials connected by ohmic contacts. These are stacked such that wider band gap materials are nearer to the illumination source, allowing the lower energy light to pass through to the next material. This way, more photons may be absorbed and higher efficiencies may be attained. Tandem cells may overcome the energetic mismatch of the III-V materials. The highest solar-to-hydrogen efficiency PEC cell is a tandem cell using p-GaInP$_2$ on a p/n GaAs junction, which is the 12.4 % cell mentioned in the previous section[14]. The excited electron from the top p-GaInP$_2$ layer reduces hydrogen while its hole combined with an excited electron from the GaAs layer. The hole left in the GaAs then proceeds to the metal cathode to drive the oxidation process. Of course, the problem of stability and cost still remains.

**Other:** Many other materials and strategies have been employed for PEC applications. Metal sulfides (e.g. MoS$_2$), particle suspensions, protective coatings, and hybrid architectures, just to name a few. None have thus far come close to addressing even a majority of the requirements for successful water splitting application, although each are significant pursuits. For more thorough discussions of these and other developments, the reader is referred to the following review articles: [11, 12, 23, 26, 125, 126].
Nanowires for PEC

One example of a modification to an existing material to improve PEC performance is morphology. In this regard, the use of nanowires can be advantageous. Nanowires offer a high surface-to-volume ratio, which means that using nanowires rather than a flat surface increases the reaction surface area leading to greater current. Nanowires can have fewer (or no) grain boundaries[44, 103, 104], which are a serious problem in polycrystalline films because they act as electron-hole trap sites[46]. Furthermore, nanowires are an excellent platform for doping and alloying studies. One way to increase the STH efficiency of hematite, for example, is to minimize the distance through which the minority carriers must diffuse, thus reducing the probability of recombination losses[67]. The geometry of nanorods/nanowires achieves just this, and in addition the perpendicular orientation better facilitates charge transport to the back contact without loss due to random pathways such as in nanoparticle systems. Reducing the feature size, to sub 5 nm dimensions may lead to quantum confinement[127], which may actually be beneficial if it leads to a decrease (upward shift) in the conduction band energy without a significant increase in the total band gap. 1-D nanostructures are relatively new in this field, but several studies have already demonstrated that they perform better than particles or thin-films.

Several groups synthesized TiO$_2$ nanowires and nanotubes and demonstrated improved performance compared to films or particles[22, 24, 25]. One study in particular found that the nanowires achieve a two-fold increase in photoconversion efficiency over a single-layer film[22], and another study demonstrated a twenty-fold increase in photocurrent over a nanoparticulate film[24]. These studies have attributed the increased
activity to increased surface area and reduced grain boundaries. These observations are not limited to TiO$_2$, however. Other materials, such as hematite—as discussed above—and ZnO have been shown to benefit from 1-D geometries for photoelectrochemical water-splitting. An array of ZnO nanorods exhibited a photocurrent twice that of a ZnO thin film in the same study[33].

Synthesis of hematite nanowire or nanorod architectures has been demonstrated using different methods[102-104, 110, 111, 127-132]. Using pure oxygen RF plasma, nanowire arrays of several oxides were synthesized in a matter of seconds[103]. Subsequent studies of showed that the hematite nanowires were single-crystalline and exhibited a superstructure of repeating oxygen vacancy planes parallel to the growth direction along the (001) basal plane[104, 105]. As mentioned earlier, hematite exhibits higher conductivity along the (001) plane, which means that these nanowires may exhibit excellent charge carrier conductivity to the back contact. Oxygen vacancies in hematite are traditionally responsible for significant losses in charge carrier conductivity, so the potential advantage of these nanowires for PEC electrolysis is that the carriers may conduct to back contact without encountering vacancy trap sites. Discoveries such as these continuously demonstrate the benefits of nanowire architectures for PEC electrolysis.

**Purpose and Intent of this Study**

This study reports different methods for synthesizing hematite nanostructures, with a focus on nanowires, and their respective performance for PEC water splitting.
Primarily, this compares PEC performance of hematite electrodes produced by direct thermal oxidation and plasma oxidation methods, two of more promising and scalable methods.
II. INSTRUMENTATION AND EQUIPMENT:

The section includes descriptions of the tools, equipment, and methods used in the study. Experimental conditions and parameters will be described in section III.

For synthesis:

- Atmospheric microwave plasma (AMWP) jet reactor
- Ambient furnace oven

For characterization and analysis:

- Photoelectrochemistry (PEC) setup
- Scanning electron microscope (SEM)
- Electron diffraction spectroscopy (EDS)
- Raman and photoluminescence (PL)
- Transmission electron microscope (TEM)
- Ultra high vacuum (UHV) system equipped with ultraviolet photoelectron spectroscopy (UPS) and x-ray photoelectron spectroscopy (XPS)
- UV-Vis
- X-Ray diffraction (XRD)

**Atmospheric Microwave Plasma Jet Reactor**

Plasma oxidation was performed using an in-house designed and assembled microwave plasma reactor fitted with a vertical 1.5” diameter quartz tube[133]. A delivery chuck at the top allowed for gases to be introduced in a concentric fashion to
serve both as a cooling sheath for the tube to keep the reacting powder in the center. The reactor can operate at a pressure range of a few torr and powers of 300 W to 3 kW. The sustained plasma jet ranged was 12 to 15 in. The schematic is shown in Figure 7.

Figure 7. Microwave plasma reactor designed to create a plasma jet at atmospheric conditions. Metal powders fed from the top form metal oxide nanowires collected at the bottom[133].

**Ambient Furnace Oven**

Thermal oxidation synthesis was performed in a Barnstead Thermolyne 1400 Furnace. It is capable of operating at temperature ranging from room to 1000 °C.

**Photoelectrochemistry Setup**

The PEC test instrumentation include:
• Princeton Applied Research Model 273A Potentiostat/Galvanostat
• Three-electrode cell glass cell with a quartz front window.
• Oriel 300W Xe lamp solar simulator from Newport Instruments
• Newport model 77330 monochromator
• Thorlabs D10MM power meter with model PM100 readout
• Computer with PowerSuite electrochemistry software
• Glass cell with a quartz window and two compartments separated by a porous glass frit
• Platinum mesh counter electrode
• Several different reference electrodes were used
  o Ag/AgCl, MF-2052 from Bioanalytical Systems, Corp
  o Standard Calomel Electrode (SCE), Accument 13-620-51
• Ultra High Purity N2 line for sparging

The glass cell has two compartments to isolate the WE and CE so that the evolved O2 and H2 may be collected separately. In this study, only the electrochemical data was analyzed for performance evaluation. Therefore, all three electrodes (WE, CE, RE) were placed in a single compartment to eliminate any contribution to resistance to ion flow by the glass frit. A typical setup is shown in Figure 8.
An SEM is a surface analysis technique particularly useful for topographical and morphological assessment. An FEI Nova 600 NanoLab SEM was used to analyze the synthesized samples. It uses a field emission gun to generate an electron beam which is focused with electromagnetic lenses and apertures onto the sample. Scanning coils then raster the beam across the sample. Interaction of the beam with the sample emits Auger electrons, X-rays, backscattered electrons, cathodoluminescence, and secondary electrons. Backscattered electrons are the result of elastic interaction, in which case energy is conserved, while the other emissions are inelastic interactions. Secondary
electrons, which are emitted after the primary electron (incident beam) are absorbed, are typically used for surface topography imaging. An “In-Lens Detector” was used to collect only the secondary electrons.

**EDS**

Electron diffraction spectroscopy (EDS) is used to analyze elemental composition. A detector collects the X-ray emission resulting from the electron beam and sample interaction in an SEM. Each element has a unique core shell structure, which results in unique X-ray signals. A commercial system from EDAX was used for the EDS. The instrument was setup in a JEOL 5310 SEM with Li thermionic emission source.

**Raman and Photoluminescence**

Raman is a technique primarily used to evaluate the phase of materials, as well to confirm the composition. A focused monochromated infrared laser interacts with the sample, resulting in inelastic scattering which is collected by a detector. There is a material phase-specific change in the energy of the scattered photons from the source laser, which is known as the Raman shift. Photoluminescence is a similar technique performed in the same instrument, but it uses a high energy UV laser to determine the energy band structure of a material. The band gap and defect states within it may be detected. A Renishaw Invia Micro Raman system was used. It has He-Cd (325 nm) and Nd-YaG (633 mn) lasers for the PL and Raman analysis, respectively. The resolution of the Raman spectroscopy in this setup is 1 micron.
**UPS**

Ultra violet photoelectron spectroscopy (UPS) is a surface study techniques. It involves exposing a sample to UV light, which causes excitation of valence electrons. It is used to analyze the valence band structure, and particularly the Fermi level energy, conductivity type, of a semiconductor, and work function. This technique is highly sensitive to the top few nanometers, making it an excellent technique for study a material surface, adsorbates, and functional groups. The analysis is performed under highly controlled ultra-high vacuum conditions. A VG Scientific / RHK 62 Technology multi-chamber UHV surface science system was used, with a 150 mm radius CLAM 4 hemispherical analyzer. A differentially pumped He-discharge lamp was used to generate UV radiation.

**UV-Vis**

UV-Vis spectroscopy is a versatile tool for studying optical properties of materials. Absorbance, transmission, or reflectance data are collected, from which one can determine the band gap value and type (in/direct) of semiconductors, among other valuable information. For solutions, this technique can also be used to determine the concentration of solutes. Light impinging on a sample is absorbed, transmitted, or reflected. The degree to which each of these happens depends on the particular material of interest. Performing calculations and analysis will be discussed in the Results section.

A UV-Vis spectrometer uses multiple light sources (tungsten filament for visible region and deuterium lamp for ultraviolet region), a grating to monochromate the light, and a photodiode or CCD detector. For solutions, the monochromated beam is split into
two by a half-mirror after which one beam goes through the reference solution (usually pure solvent) and another goes through the sample. The transmitted light is then collected by the detector and the software calculates the absorbance/transmittance values. Diffuse reflectance measurements are performed for opaque solid samples using a diffuse reflectance integrating sphere. The sphere has ports for the incident beam, the sample, and the detector. A plug is positioned at an appropriate angle to absorb the specular reflectance—only diffuse reflectance should be collected for the measurement. The shape of the sphere channels the diffuse reflectance to the detector port. A highly reflective standard (typically Ba$_2$SO$_4$ or PTFE) is used as a backing for a sample so that any transmitted light is reflected back. A Perkin Elmer Lambda 950 UV-Vis spectrometer was used in this study.
III. PROCEDURE/EXPERIMENTAL METHODS

**RF Plasma Oxidation**

Commercial iron sheets (98%) 3mm thick were exposed to an O-rich RF glow discharge plasma at low pressure (100 Pa) for 90 seconds. The process is described in detail in several publications[103, 104, 128, 134].

**Atmospheric MW Plasma**

Iron sheets (99.5 %, from Advent Research Materials) 2 mm thick were cut into one square centimeter pieces. The pieces were then sanded down (220 grit) to remove any native oxide or surface contamination, cleaned with ethanol, and promptly dried with Kim Wipes. An atmospheric plasma jet reactor, described elsewhere[133], was used to generate a plasma consisting of air, argon, and oxygen. The setup was modified for this synthesis method such that the plasma flame was directed upwards. The flow rates varied but were usually about 15 lpm, 2 lpm, and 500 sccm, respectively. The iron pieces were then exposed in the plasma jet. The iron pieces were held in the plasma flame with tweezers about 3” from the base. Exposure time varied from a couple to twenty minutes.

**Ambient Oven Oxidation**

Iron sheets (same as above) were spaced out on aluminum foil, pressed down to ensure good contact, and placed in a furnace oven pre-heated at 500 °C. Although 5 hours was enough to grow a layer of nanowires, ribbons, flakes, and belts, the samples were held in the oven for 12 hours.
Atmospheric Plasma Torch Powder

The atmospheric plasma jet reactor shown in Figure 7 was used with a (∼ 10") plasma consisting of 12.45 lpm of air, 2 lpm of Ar, 300 sccm of H2, and 500 sccm of O2. A pump was used to draw the gas (and plasma) downward. Iron powder (<10 µm, Sigma Aldrich) was slowly poured from the top. The powder reacted as it fell through the plasma by gravity. Products were collected in a cup placed directly below and from a filter (1 µm) placed in the way of the exhaust.

Electrodeposition of Fe Thin Films and Pt Surface Catalyst

Electrodeposition on Fe onto conducting substrates (e.g., glass slides coated with fluorine doped tin oxide, or FTO) was performed using the same electrochemistry instrumentation as for the PEC setup described in the previous chapter. Using references [135, 136] as examples, an electrolyte solution was prepared containing: 0.075 M H2SO4, 0.9 M FeSO4·7H2O, and 0.15 M FeCl3·4H2O. Before any set of experiments, the solution was sparged with high purity N2 for approximately 10 minutes. The electrodes were then submerged in the solution, with the WE lead connected to the substrate (FTO), the CE lead connected to an Fe foil (99.5%, 0.025 mm, Alfa Aesar), and the RE shorted with the CE. The solution was constantly agitated during deposition using a magnetic stir rod. The PowerSuite software was used to setup a Galvanic Square Wave experiment wherein the appropriate current was pulsed for one second and then zero current for one second, repeated. The current pulse was calculated based on the substrate area, desired film thickness, and desired time of experiment. For example, with an immersed FTO area of 9.1 cm² and a desired film thickness of 1·10⁻⁴ cm (1 µm), the total volume of Fe is 9.1·10⁻⁴ cm³, corresponding to 1.3·10⁻⁴ moles (ρ = 7.874 g/cm³, MW = 55.845 g/mol), or 12.4 C
For a twenty minute experiment (total time), the current pulse needed to be 20.6 mA (12.4 C / 600 sec).

In some cases, minute amounts of platinum were electroplated onto the semiconductor electrodes to enhance catalysis of the oxidation reaction. As above, a two electrode setup was used. The electrolyte was Platinum AP RTU solution from Technic Inc. A galvanic square wave function was used, wherein current was applied for 0.25 seconds and zero current was applied for 2 seconds. The cycle was repeated until 10 mC/cm² was achieved.

**Electrode Preparation**

For PEC characterization, it necessary to have only the semiconductor surface exposed to the electrolyte and to have a low-resistance ohmic contact. The following procedures were applied for Fe₂O₃ films on 1 cm² iron substrates: 1) the oxide on one side was sanded down until only the metallic shine of iron was exposed; 2) a copper wire was coiled at one end to an approximate diameter of 1 cm², and then one side of the coil was sanded down to remove native oxide; 3) after spreading silver epoxy (CircuitWorks two-part conductive epoxy) on the sanded side of the copper coil and on the sanded side of the sample, the sample was pressed onto the copper; 4) the assembly was then held in an oven heated to 80 – 120 °C for about 20 minutes to cure the epoxy; 5) the assembly was then inserted into glass tubing (copper tail first), such that some of the copper wire sticks out at the end and the other side of the glass tubing is touching the coil/sample; 6) a thick layer of Hysol 9462 epoxy was spread onto the sample area of the assembly such that everything except the Fe₂O₃ surface was insulated; 7) this assembly was put into the oven at 80 °C for approximately 2 hours, or until the epoxy was hard; 8) a thin layer of
Hysol E-120HP was then spread over the previous epoxy layer; 9) this assembly was then put into the oven at 80 C, or until the epoxy was cured; 10) before performing any tests, the tail end of the copper wire was sanded down to remove any oxide that developed while in the oven. Figure 9 shows the electrode at different points in the above procedures. Hysol 9462 may be used alone, but Hysol E-120HP was added for extra protection against corrosion.

Figure 9. A picture showing the different steps of making a typical electrode.
Some samples in this study required slight modifications to the above procedures. For samples on FTO (Hartford Glass, TEC 8) glass, the oxide film was only in the center and the outer edges were covered with conducting silver epoxy. Then, copper wire was placed in good contact with the silver epoxy and the assembly was cured, following by coating with the insulating epoxies. Figure 10 shows a typical FTO electrode before and after coating with insulating epoxy.
Figure 10. FTO electrodes showing how conducting contact was made. The bottom image was taken after coating the electrode shown at the top with insulating epoxies.

The final procedure was to calculate the geometric surface area of the semiconductor surface area. Using a copy machine, the electrodes were copied with printed, oxide side down, with 200% magnification. The image colors were inverted such that the oxide part of the image printed out as solid white while the rest was dark. Then, grid paper was also copied with 200% magnification. A square was cut out of the
copied grid paper corresponding to 1 cm$^2$ on the original, and weighed. Then, the semiconductor area of the copied samples was cut out and also weighed. The surface area was then determined using the following Equation (11):

$$\frac{\text{sample cut-out mass}}{1 \text{ cm}^2 \text{ grid mass}} \times 1 \text{ cm}^2 = \text{sample area}$$

**Photoelectrochemistry**

*Open Circuit Potential (OCP):* As discussed in the theory section, the bands within a semiconductor will flatten out upon illumination. Bending occurs in opposite direction for n-type and p-type semiconductors. Measuring the potential of a semiconductor in an open circuit before and after illumination will therefore reveal its conductivity type. This test is called OCP. A positive potential shift upon illumination indicates p-type conductivity. OCP measurements were performed using a three-electrode setup in 1 M KOH solution with AM 1.5 (100 mW/cm$^2$) illumination. Acidic solution proved to be corrosive for the samples. In order for the potential readings to reach equilibrium, OCP was typically performed for a duration of about 180 seconds, with light being turned on at 90 seconds.

*Current Density-Voltage (J-V):* J-V tests may be performed in a two or three electrode setup. Potential is applied to the sample at a specified scan rate within a specified potential window, and the current is measured. In this study, the scan rate was 25 mV/s and the solution was 1 M KOH. These tests may reveal a myriad of information about the material and its behavior under PEC conditions. Two electrode tests are run to determine the STH and three-electrode measurements are used to characterize energetics and kinetics at the semiconductor. J-V scans are run in dark and subsequently in light,
and the photocurrent is determined by the absolute value of the difference. Samples are normally biased in the positive direction for n-type samples and in the negative direction for p-type samples. A typical dark/light J-V scan for an n-type semiconductor may look as shown in Figure 11. Inversion occurs when enough bias applied to band the bends such that the Fermi level is in the valence band at the surface, in which case the surface is flooded with holes and the semiconductor exhibits metallic conductivity. Operating in this region may lead to corrosion of the material. The dark current onset potential corresponds to the onset of inversion. The photocurrent onset correlates to the potential at which the band edges the charge carriers are energetic enough to drive the redox reactions. Refer to Figure 6 for band energetics diagrams.

![Graph of J-V scan](image)

Figure 11. A typical dark and light J-V scan for an n-type semiconductor.

**UPS**

Gold was sputtered on about a third of the surface of each sample for reference and calibration. The instrument has a work function of 4.5, which cause the low kinetic
energy (KE) peaks of the samples to be hidden. Therefore, a battery was used to apply a bias greater than 4.5 V to the sample. The tests reported used three different bias values, 5.68, 5.81, and 7.40 V.
IV. RESULTS AND DISCUSSION

This study involved synthesis, structural characterization, and PEC properties and performance analysis of each sample. Also, different types of samples were synthesized and tested. This section will therefore present and discuss findings in the above order.

Synthesis

Figure 12 presents SEM images of the results of direct plasma oxidation of iron substrates by RF oxygen plasma and of NPs grown by plasma oxidation of iron powder. The NWs (a) are approximately 100-200 nm at the base and are one to three microns long, and cover the most of the iron substrate surface. The NPs aggregated into large clumps, but individually vary in size from 10 to 100 nm.

Figure 12. SEM images of hematite (a) NWs grown by direct plasma oxidation of iron and (c,d) NPs also grown by plasma oxidation.
Thermal oxidation of Fe sheets was performed at three different temperatures: 500 °C, 600 °C, and 800 °C. These temperatures were chosen to encompass and exceed the Fe-O transition temperature for α-Fe₂O₃ (570-580 °C) [MIT database] and because previous studies suggested that this is an appropriate range[111]. At 500 °C, three types of morphologies were observed: nanowires, nanoflakes, and larger wave-like nanoribbons. The nanowires were visible when looking at a curved surface or when tilting the sample. The nanowires occurred in dense arrays and were on the order of 5 µm in length and tapered—from 100 nm to 10 nm, roughly. The nanoflakes uniformly covered the entire surface. Their dimensions were roughly 1 µm at the widest point and tens of nanometers thick, though that was difficult to measure from SEM images. The nanoribbons—typically a few µm tall, tens of nanometers thick, and extending out for several µm—sometimes occurred in small or large batches but usually they were uniform throughout. All three morphologies existed in the same locations, densely packed together. The results for 600 °C were less consistent, yielding either only nanowire arrays or a combination of nanowires and nanoflakes, but never nanoribbons. Figure 13 shows SEM images of the thermal oxidation results, except for samples oxidized at 800 °C. In the latter case, the samples lacked the distinct rust color of hematite and SEM images revealed an amorphous top layer. This indicates that a molten layer existed which then solidified without forming nuclei for nanowire (or other morphology) growth. All subsequently tested on thermally oxidized samples were grown at 500 °C.
Figure 13. SEM images of thermally oxidized Fe sheets at (a-b, e) 500 °C and (c-d, f) 600 °C. Flakes and wires grew in all experiments, but larger ribbons were observed only at 500 °C. Oxidation at 800 °C (not shown) resulted in an amorphous surface layer.
**Characterization**

**Raman**

Raman was performed on NWs grown by O$_2$ plasma treatment. The Raman peaks, shown in Figure 14, agree well with those reported earlier[104, 111, 137], confirming the $\alpha$-Fe$_2$O$_3$ phase. Most of the peaks for thermally oxidized samples are slightly shifted positive from those of the plasma oxidized. This may be due to laser heating, however, because a higher intensity was used.

![Figure 14. Raman on NWs grown by O$_2$ plasma oxidation.](image-url)
**Photoluminescence**

Low temperature visible-range photoluminescence performed on O$_2$ plasma synthesized NWs (Figure 15) shows two distinct energy levels at 2.05 and 2.15 eV.

![Photoluminescence Spectrum](image)

Figure 15. Cold photoluminescence on α-Fe$_2$O$_3$ synthesized by O2 plasma oxidation.

**UV-Vis**

UV-Vis spectroscopy was performed to characterize the band gap of the α-Fe$_2$O$_3$ NWs. It was necessary to use diffuse reflectance scans because the samples were opaque. The diffuse reflectance data was converted to absorbance using Equation (12):

\[ A = R_{\text{max}} - R \]  

where $R_{\text{max}}$ is the maximum R value beyond the dip in diffuse reflectance. With this formula, the maximum absorbance is set to zero where the curve representing the band
gap dips. The band gap is then determined by extrapolating the straight portion of the curve. This method is discussed further in reference [138]. Figure 16a shows the converted absorbance plot with the long wavelength edge extrapolated to $E_g = 2.1$ eV, which is in agreements with previously reported estimates[59, 139]. Another method for determining the band gap is based on the absorption coefficient, $\alpha$:

$$\alpha E_{hv} = A(E_{hv} - E_g)^m$$  \hspace{1cm} (13)

$$\therefore (\alpha E_{hv})^{1/m} \propto (E_{hv} - E_g)$$  \hspace{1cm} (14)

where $A$ is a constant, $E_{hv}$ is the energy (eV) of an impinging photon, $E_g$ is the band gap, and $m$ is a constant depending on the type of transition ($\frac{1}{2}$ for direct and 2 for indirect). The absorption coefficient is determined by normalizing $A$ to material thickness. It is unclear, in this case, whether the material thickness would correspond to the dimensions of the NWs, or if it would include the underlying oxide or metallic layers. The normalization would contribute a constant to relation (14), keeping the proportionality true. Tauc plots for both direct and indirect transitions for the same wavelength were calculated and are shown in Figure 16b (inset = indirect). Normally, the plot that is more accurately extrapolated with a straight line represents the band gap, but the difference in this case is minimal. The band gap nature of $\text{Fe}_2\text{O}_3$ has been debated in many publications and it is generally agreed that it has an indirect transition at around 2.1 eV due to the spin-forbidden $\text{Fe}^{3+} 3d \rightarrow 3d$ excitation[48]. It is thus safe to say that these samples also exhibit an indirect band gap of 2.1 eV.

Similarly, an absorbance plot was calculated from the diffuse reflectance data for thermal oxidation. Two significant dips in absorption were observed correlating to 2.09
eV and 1.63 eV. The first is the expected indirect band gap for hematite, but the lower energy transition is unexpected. One possible explanation is the presence of mixed phases due to partial oxidation.

Figure 16. UV-Vis plots estimating band gap of Fe2O3 samples: absorbance plots for (a) plasma oxidized and (c) thermally oxidized samples, and Tauc plots (b) for plasma oxidized samples (large graph is for direct and inset is for indirect transition).

**Conductivity Type: Open Circuit Potential**

Open circuit potential (OCP) measurements were conducted in order to determine the conductivity type of the electrodes (n- or p-type). When going from darkness to illumination, if the potential of the working electrode decreases (more negative), then it is an n-type semiconductor.
The first half of the OCP curves occurred under dark conditions and the transition represents when the light was turned on. These are presented in Figure 17. The solution was 1M KOH in all the tests. The samples synthesized by O\textsubscript{2} plasma (a) showed an n-type behavior, repeatedly. The absolute value of the potentials shifted positively with each successive OCP trial. This could be due to slow equilibration of the Helmholtz layer and/or slow kinetics for charge transfer across the surface. Samples synthesized by thermal oxidation (b) in air, however, seemed to exhibit p-type behavior. This was a peculiar finding because no doping had been done. Suspecting a surface impurity effect, the samples which were used for UPS—which thus spent much time under ultra high vacuum—were tested for OCP. Consecutive OCP measurements revealed that a transition from n-type behavior to p-type behavior occurred during the scans, as can be seen in (c). After p-type behavior was observed, the sample was then placed in a vacuum chamber (~0.1 torr) overnight. The very next OCP scan (d) again showed n-type behavior, which diminished with further consecutive runs.

N-to-p-type (and p-to-n) transitions have been reported for metallic oxides in the past, attributed to a variety of surface chemistry reactions[140-145]. It is known that metal oxides are capable of chemisorptions of gaseous species at the surface due to oxygen vacancies and surface states[146]. This is likewise true for liquid medium. In solution, the material surface is functionlized with OH groups[147]. The n-to-p-type transition of \(\alpha\)-Fe\textsubscript{2}O\textsubscript{3} has been explained by the adsorption of oxygen groups on the surface, which increases band bending to the point that the Fermi level is nearer the valence band than the conduction band at the surface—a condition that exists for p-type semiconductors. Although this explanation is offered, it cannot be readily accepted. It
has been argued that surface chemisorption on semiconductors in liquid medium changes the energies of the surface and has the effect of unpinning the band edges. Furthermore, the potential shift observed in OCP is due to the flattening of bands upon illumination. The direction of the flattening is opposite to that of the bending which occurs when the Fermi levels equilibriate. In other words, even if the bands bend so much that the Fermi level approaches nearer to the minority band edge, the shift observed in OCP upon illumination should still be in the opposite direction of bending. This phenomenon needs to be studied further.
Another test that may determine conductivity type is UPS. In the high kinetic energy (KE), the onset of data corresponds to the Fermi level position in a material. An offset between the gold onset and that of the material of interest correlates to the energy gap between the valence band maximum and the Fermi level. A Helium 1 scan for gold and a thermally oxidized sample are shown in Figure 18. UPS measurement scans on gold and hematite using He 1 excitation. The 1.6 eV offset confirms that the thermally oxidized iron oxide samples are n-type.

**UPS**

Figure 17. (a) O₂, progressive OCP. Consecutive shifts positive. (b) thermal, OCP, p-type. (c) consecutive, thermal, n to p. (d) consecutive (after vacuum after c), n to p.
As discussed before, reverse bias (positive for n-type) is applied to semiconductors to induce water splitting if the bands do not straddle the redox potentials of hydrogen and oxygen evolution. A forward bias shifts the Fermi level into the majority carrier band (conduction for n-type), which leads to an accumulation of majority carriers at the surface. At this point, the material exhibits metallic conductivity and no photoactivity. As another test of whether the thermally oxidized samples may have p-type conductivity, J-V scans were conducted in the forward bias direction (negative), with the results shown in Figure 19. The dark and light curves are nearly identical and crisscross each other several times, indicating a lack of photoactivity. Furthermore, the two humps between at -0.55 and -0.82 V may be due to the corrosion of iron oxide by reduction. This is supported by the fact that when the samples were removed from solution, new oxidation was seen throughout the electrode surface, and subsequent J-V measurements showed no photoactivity.

Figure 18. UPS measurement scans on gold and hematite using He 1 excitation.

$J-V$

As discussed before, reverse bias (positive for n-type) is applied to semiconductors to induce water splitting if the bands do not straddle the redox potentials of hydrogen and oxygen evolution. A forward bias shifts the Fermi level into the majority carrier band (conduction for n-type), which leads to an accumulation of majority carriers at the surface. At this point, the material exhibits metallic conductivity and no photoactivity.
tests in the reverse direction produced no photoactivity at all. This did not occur for the samples which were instead reverse biased (discussed below). Therefore, it was concluded that the thermally oxidized electrodes are n-type. The phenomenon observed in OCP measurements deserves further study, however.

![Graph](image)

Figure 19. J-V dark and light curves for forward bias of thermally oxidized hematite. Shape of curves indicates photocorrosion and no photoactivity.

J-V measurements comparing the photoactivity of plasma and thermally oxidized electrodes are shown in Figure 20. The curves for the plasma oxidized samples were performed versus SCE (+0.241 V vs. NHE), and the other curves were performed using Ag/AgCl reference electrode (+0.207 V vs. NHE). In Figure 20, all the data was adjusted to match the scale of the plasma oxidized samples (vs. SCE). Dark and light scans are shown for each type. Consistently, the photocurrent onset in all cases is -0.3 V vs. SCE, which indicates that the flat band potential is the same for all three types of samples. The plasma oxidized sample produced much greater photocurrent, however, than the
thermally oxidized samples or the NPs. At +0.3 V vs. SCE, the photocurrent was 255, 2.6, 11.2 µA/cm² for the plasma, thermal, and NP samples, respectively. In all cases, the dark current onset was between +0.4 and 0.5 V vs. SCE. For the NW samples (plasma and thermal), the light current was considerably greater than the dark current even past this point, indicating considerable photoactivity. The dark onset normally corresponds to inversion due to external bias, however, and therefore is not an interesting region for operation in practical applications. The light and dark curves were nearly identical past the dark onset for the NP samples.
These results suggest that the plasma oxidation method is better for producing hematite electrodes capable of photovoltaic water splitting than thermal oxidation. In order to understand the drastic difference between the two types of
samples, the interface between the nanowire layer and the iron substrate was analyzed. This was done by scratching the samples and then checking the exposed layers with EDS for presence oxide. This is shown in Figure 21, where part (a) is for the plasma samples and part (b) is for the thermal samples. Scratching reveals the presence of several layers: a top layer upon which the nanostructure grow, a middle layer, and a bottom layer. For the plasma samples, EDS scans show that the presence of oxidized iron in the top layer and at the top of the middle layer, but not below. This suggests that only the full top layer is oxidized iron, while the middle and below layers are pure iron. For the thermal samples, however, the middle layer also shows a strong presence of oxygen, suggesting that the whole region is oxide. From the SEM images—(c) for plasma and (d) for thermal—the thickness of the total oxide layer layers is determined to be about 1 µm and 7.5 µm for the plasma and thermal samples, respectively.

The interfacial layer is detrimental to PEC performance. Other studies have also reported the presence of an interfacial layer between the iron substrate and the hematite surface when grown by direct oxidation[111, 148]. It was shown to be an amorphous layer comprised of Fe3O4 (magnetite) and FeO (wüstite)[149-151]. Due to the mixed phase and poor quality of this layer, charge carriers generated in the surface hematite nanostructures are lost to recombination. Therefore, the advantages offered by the nanowire morphology are negated in the interfacial layer. The large thickness of the interfacial layer in the thermally oxidized samples may thus be an explanation for the poor photoactivity, despite the presence of hematite nanowires on the surface, making it even less photoactive than the NP samples.
The interfacial layer resulting from plasma oxidation may be different than from the well studied thermal oxidation process. Growth of a hematite layer by thermal oxidation is a slow process taking several hours, at the minimum. Hematite can be grown very quickly—in a matter of minutes or seconds—by plasma oxidation, however. Typically that fast processing may lead to metastable phases whereas slow processing leads to equilibrium conditions. A well known example is behavior of iron and carbon during the making of steel. Hot iron is quenched quickly in order to capture more carbon in the iron lattice, to produce tougher steel. In the mechanism proposed for plasma oxidation, initial exposure to plasma causes spontaneous iron oxide nucleation at the immediately at the iron-plasma interface. The nanowires were grown when the temperature was near that of the Fe-O phase-transition for hematite, but below 780°C, in which case the limited mobility of the iron atoms allows for growth to occur only at the nuclei-metal interface. The original nuclei form the tip of the growing nanowires. There is minimal oxide layer below the body of the continuously growing nanowires and the metal substrate. During shutdown, however, the conditions for growth are lost and during the cooling process an oxide interface may form because of the trapped immobile O-atoms. All this occurs in a matter of seconds. Plasma oxidation does not follow the same growth process as the slower thermal oxidation, in which growth of Fe2O3 is preceded by the development of Fe3O4, which is preceded by an FeO layer. The long duration of thermal oxidation experiments gives more time for the diffusion of O-species farther below the surface of the iron substrate. Further analysis of the interfacial layer is currently underway to establish which oxide phases are present in the interface layer of plasma oxidized samples.
Figure 21. A study of the interfacial iron oxide interfacial layer for plasma (a, c) and thermally (b, d) oxidized samples. The interfacial layer is 1 µm and 7.5 µm for the plasma and thermal samples, respectively.
These data show that plasma oxidation may be the best route for producing hematite samples for solar hydrogen applications. The material may still benefit from the findings of previous studies, such as by the surface treatment with fluorine to raise the shift the conduction band negatively. These studies should be performed on hematite synthesized by plasma oxidation, however.
V. CONCLUSIONS

- Hematite is an excellent material for photoelectrochemical electrolysis because of its 2 eV band gap, wide abundance, and low cost. Nanowire morphologies offer further benefits, including high crystallinity, high surface area, ordered oxygen vacancies parallel to the growth direction, and an excellent substrate for doping studies.

- Hematite (α-Fe₂O₃) nanowire arrays were grown on Fe sheets by direct plasma oxidation and by direct thermal oxidation. The plasma oxidation method takes seconds, whereas thermal oxidation requires several hours.

- UV-Vis measurements confirmed a 2.1 eV band gap for both types of samples. Thermally oxidized samples also showed a transition at 1.63 eV, which may be due to the presence of mixed phases.

- Open circuit potential tests confirmed that the plasma oxidized samples were n-type. OCP measurements show a transition from n-type to p-type behavior over time for thermally oxidized samples. N-type conductivity was confirmed by ultraviolet spectroscopy and by current-voltage measurements, however. The phenomenon observed in the OCP measurements is not yet understood.

- The nanowire arrays grown by plasma oxidation showed far superior photoactivity than those grown by thermal oxidation. This is attributed to the presence of a thick mixed-phase interfacial layer where charge carriers are lost due to recombination. The plasma oxidized samples had a much smaller interfacial layer. The composition of the interfacial layer in plasma oxidized samples is currently being analyzed.
• It is concluded that plasma oxidation should be used to produce hematite samples for studying photoelectrochemical performance.
VI. RECOMMENDATIONS

- The phenomenon responsible for the n-to-p-type behavior in OCP measurements may be interesting and beneficial to analyze and explain.
- The interfacial layer in plasma oxidized hematite should be characterized because the different growth mechanism may mean that this layer is far different than that observed in thermally grown samples.
VII. REFERENCES


VIII. VITA

Boris Chernomordik received his B.S. in Chemical Engineering Summa Cum Laude from the University of Louisville in May 2008. He will pursue a doctoral degree in Chemical Engineering from the University of Minnesota, Twin Cities, with a National Science Foundation Graduate Fellowship.